



DMT10H015LFG

Product Summary

BV _{DSS}	R _{DS(ON)} max	Ι _D T _C = +25°C
	13.5mΩ @ V _{GS} = 10V	42A
100V	18mΩ @ V _{GS} = 6.0V	36A
	23.5mΩ @ V _{GS} = 4.5V	32A

Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Synchronous Rectifier
- Backlighting
- Power Management Functions
- DC-DC Converters

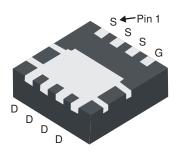
100V N-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

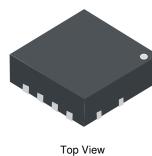
- Low R_{DS(ON)} Ensures On State Losses Are Minimized
- Excellent Q_{gd x} R_{DS (ON)} Product (FOM)
- Advanced Technology for DC/DC Converters
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies Just 33% of The Board Area Occupied by SO-8 Enabling Smaller End Product
- 100% UIS (Avalanche) Rated
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

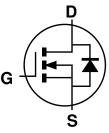
Mechanical Data

- Case: PowerDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.008 grams (Approximate)



Bottom View





Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging	
DMT10H015LFG-7	PowerDI3333-8	2,000/Tape & Reel	
DMT10H015LFG-13	PowerDI3333-8	3,000/Tape & Reel	

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

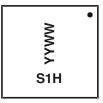
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:



S1H = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 17 = 2017) WW = Week Code (01 to 53)

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Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	100	V	
Gate-Source Voltage		V _{GSS}	±20	V	
Continuous Drain Current (Note 5) V _{GS} = 10V	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	10 8.0	А	
	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	ID	42 26	A	
Maximum Continuous Body Diode Forward Current (Note 5)		Is	1.5	A	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	75	A	
Avalanche Current (L = 3mH)		IAS	7.5	A	
Avalanche Energy (L = 3mH)		E _{AS}	85	mJ	

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	PD	2.0	W
Thermal Resistance, Junction to Ambient (Note 5)		$R_{ heta JA}$	61	°C/W
Total Power Dissipation	$T_{\rm C} = +25^{\circ}{\rm C}$	PD	35	W
Thermal Resistance, Junction to Case		$R_{ ext{ heta}JC}$	3.5	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

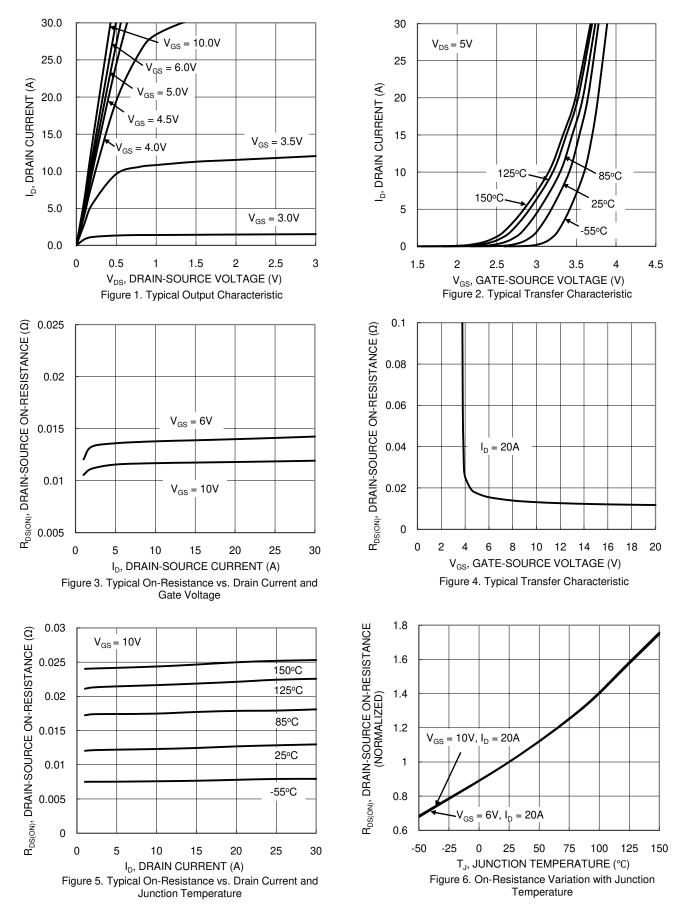
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	—	_	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	—	—	1	μA	$V_{DS} = 80V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V _{GS(TH)}	1.4	2.0	3.5	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
		—	10.8	13.5		$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	—	13.3	18	mΩ	$V_{GS} = 6.0V, I_D = 20A$	
		_	17.9	23.5		$V_{GS} = 4.5V, I_D = 20A$	
Diode Forward Voltage	V _{SD}	_	0.9	1.3	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 7)		-	-	-	-	-	
Input Capacitance	Ciss	_	1,871	—		$V_{DS} = 50V, V_{GS} = 0V$ f = 1MHz	
Output Capacitance	Coss	—	261	—	pF		
Reverse Transfer Capacitance	Crss	—	6.9	_			
Gate Resistance	R _G	—	0.75	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Qg	—	33.3	_		$V_{DD} = 50V, I_D = 10A,$	
Gate-Source Charge	Q _{gs}	_	6.9	_	nC		
Gate-Drain Charge	Q _{gd}	_	5.1	_		$V_{GS} = 10V$	
Turn-On Delay Time	t _{D(ON)}	_	6.5	_		$\label{eq:V_DD} \begin{split} V_{DD} &= 50V, \ V_{GS} = 10V, \\ I_D &= 10A, \ R_G = 6\Omega \end{split}$	
Turn-On Rise Time	t _R	_	7.0	_	ns		
Turn-Off Delay Time	t _{D(OFF)}	_	19.7	_	115		
Turn-Off Fall Time	tF	—	8.1	—]		
Reverse Recovery Time	t _{RR}	—	37.9	_	ns	I _F = 10A, di/dt = 100A/us	
Reverse Recovery Charge	Q _{RR}	_	51.9	_	nC	$TF = TUA, dI/dl = TUUA/\mu S$	

 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing. Notes:



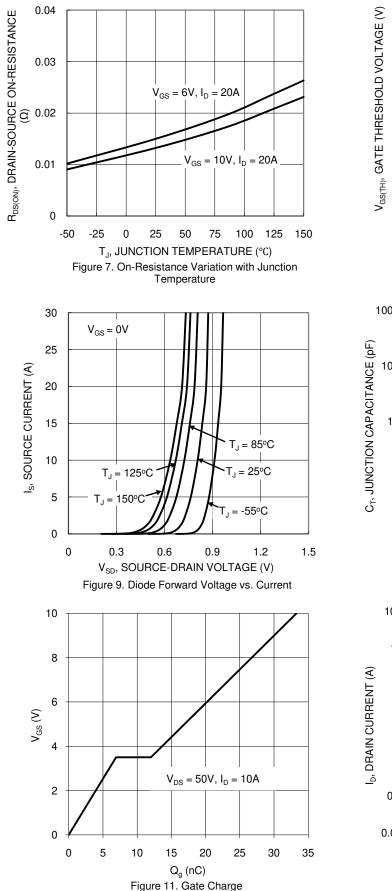
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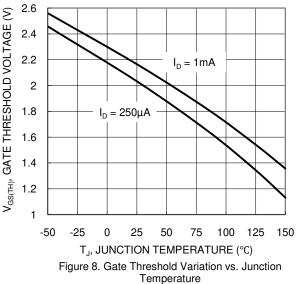


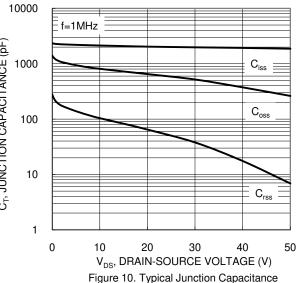
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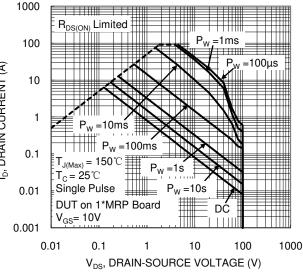
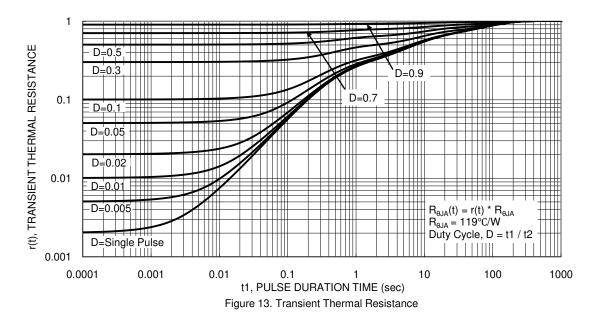


Figure 12. SOA, Safe Operation Area

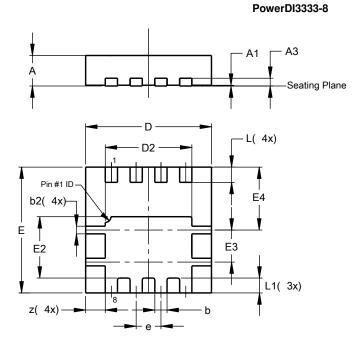






Package Outline Dimensions

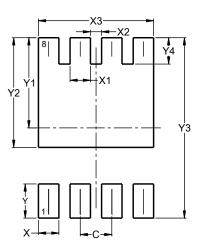
Please see http://www.diodes.com/package-outlines.html for the latest version.



PowerDI3333-8					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05	0.02		
A3	-	-	0.203		
b	0.27	0.37	0.32		
b2	0.15	0.25	0.20		
D	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
Е	3.25	3.35	3.30		
E2	1.56	1.66	1.61		
E3	0.79	0.89	0.84		
E4	1.60	1.70	1.65		
e	_	_	0.65		
L	0.35	0.45	0.40		
L1	_	_	0.39		
z	_	-	0.515		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions Value (in mm) С 0.650 0.420 Х X1 0.420 X2 0.230 Х3 2.370 Y 0.700 Y1 1.850 Y2 2.250 Y3 3.700 **Y**4 0.540

PowerDI3333-8



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